# Qualcom

RF360 Europe GmbH

# **Data sheet**

SAW RF filter Base stations LTE band 34

Series/type: Ordering code:	B5306 B39202B5306U410
Date:	June 13, 2019
Version:	2.1

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SAW RF filter B5306 Data sheet

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### Table of contents

1 Application	4
2 Features	4
3 Package	5
4 <u>Pin configuration</u>	5
5 Matching circuit	6
6 <u>Characteristics</u> .	7
7 Maximum ratings	8
8 Transmission coefficient	9
9 Reflection coefficients	
10 Packing material	
11 <u>Marking</u>	
12 Soldering profile	
13 Annotations	
	17
15 Important notes	

#### 1 Application

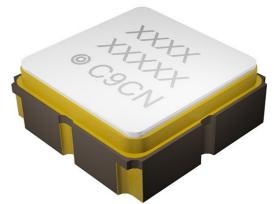
■ RF filter for LTE band 34

Qualcomm

- Unbalanced to unbalanced operation
- Low amplitude ripple
- Usable passband 15 MHz
- $\blacksquare$  Matching required for operation at 50  $\Omega$

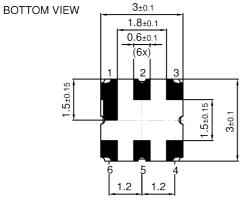
#### 2 Features

- Package Code DCC6C
- Package size 3.0±0.1 mm × 3.0±0.1 mm
- Package height 1.1±0.125 mm
- Approximate weight 0.04 g
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Lead free soldering compatible with J-STD20C
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 1 (MSL1)



**Figure 1:** Picture of component with example of product marking.

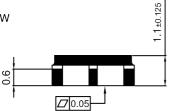
## 3 Package





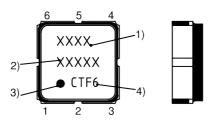
- 2 Input
- 5 Output
- 1, 3, 4, 6 Ground



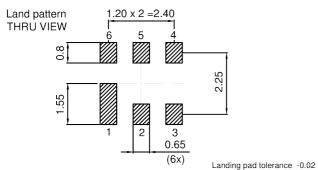


TOP VIEW

SIDE VIEW



Device designation
 Last five digits of the lot number
 Marking for pad number 1
 Example of production location and date code



**Figure 2:** Drawing of package. See Sec. Package information (p. 17).



#### 5 Matching circuit

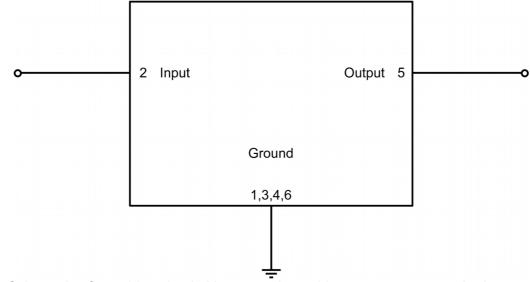


Figure 3: Schematic of matching circuit. No external matching components required.

#### 6 Characteristics

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Temperature range for specification	$T_{_{\rm SPEC}}$	= −40 °C +95 °C
Input terminating impedance	Z	= 50 Ω
Output terminating impedance	Z <sub>OUT</sub>	= 50 Ω

Characteristics				min. for $T_{_{\rm SPEC}}$	<b>typ.</b> @ +25 °C	max. for $T_{_{\rm SPEC}}$	
Center frequency			f <sub>c</sub>	—	2017.5	—	MHz
Maximum insertion attenuation			$\alpha_{_{max}}$				
	2010 2025	MHz		_	2.2	3.5	dB
Amplitude ripple (p-p)			Δα				
	2010 2025	MHz		—	0.3	1.2	dB
Maximum VSWR			$VSWR_{max}$				
@ input port	2010 2025	MHz		—	1.2	1.8:1	
@ output port	2010 2025	MHz		-	1.2	1.8:1	
Minimum attenuation			$\alpha_{_{min}}$				
	1700 1785	MHz		40	53	—	dB
	1800 1860	MHz		45	60	—	dB
	1920 1980	MHz		30	32	—	dB
	1980 1985	MHz		24	32	—	dB
	2045 2070	MHz		6	25	—	dB
	2070 2085	MHz		40	55	—	dB
	2170 4000	MHz		30	35		dB

#### 7 **Maximum ratings**

Operable temperature	<i>T</i> <sub>OP</sub> = -40 °C +125 °C	
Storage temperature	<i>T</i> <sub>STG</sub> <sup>1)</sup> = −40 °C +125 °C	
DC voltage	$ V_{\rm DC}  = 5.0  \rm V$	
ESD voltage	V <sub>ESD</sub> <sup>2)</sup> = 100 V	Machine model.
Input power	P <sub>IN</sub>	
@ input port: 2010 2025 MHz	15 dBm	Continuous wave for 100000 h @ 95 °C.
@ input port: 2010 2025 MHz	23 dBm	Continuous wave for 24 h @ 95 °C.

1)

Not valid for packaging material. Please refer to definition of Shelf life (p. 16). According to JESD22-A115B (MM – Machine Model), 10 negative & 10 positive pulses. 2)

#### 8 Transmission coefficient

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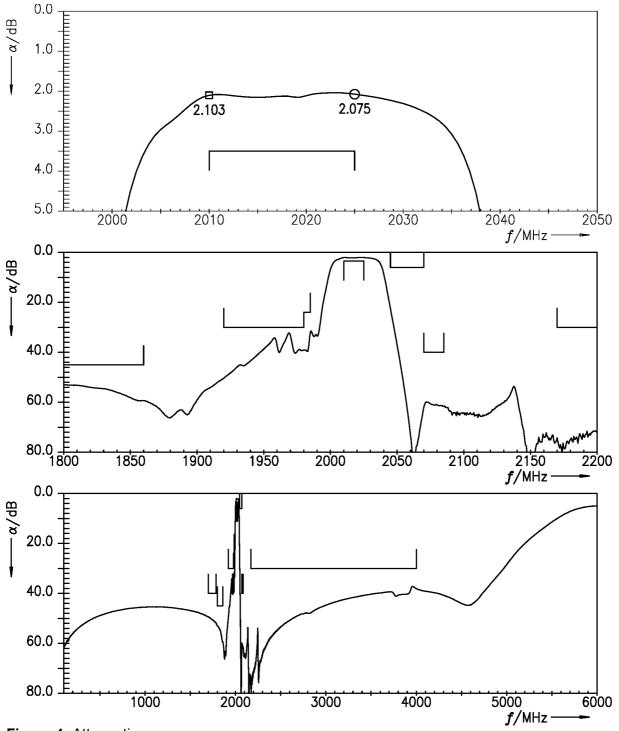


Figure 4: Attenuation.

Please read **Cautions and warnings** and **Important notes** at the end of this document.

#### 9 Reflection coefficients

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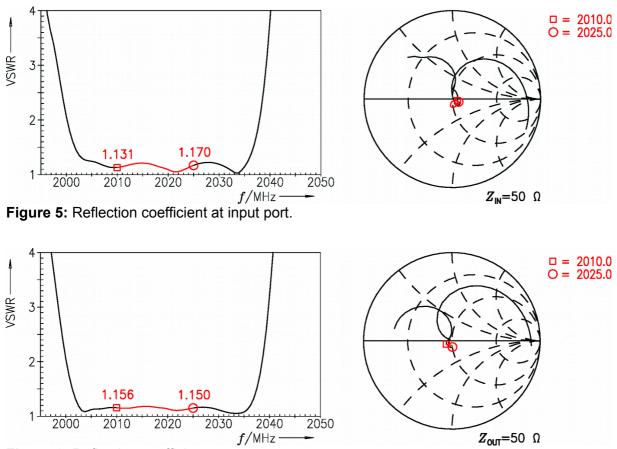
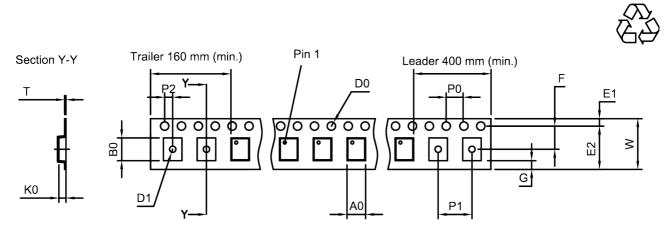


Figure 6: Reflection coefficient at output port.



#### 10 Packing material

#### 10.1 Tape



User direction of unreeling

**Figure 7:** Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

 $\begin{array}{c} A_0 \\ 3.25_{\pm 0.1} \text{ mm} \\ B_0 \\ 3.3_{\pm 0.1} \text{ mm} \\ D_0 \\ 1.5_{\pm 0.1/-0} \text{ mm} \\ D_1 \\ 1.5 \text{ mm} (\text{min.}) \\ E_1 \\ 1.75_{\pm 0.1} \text{ mm} \end{array}$ 

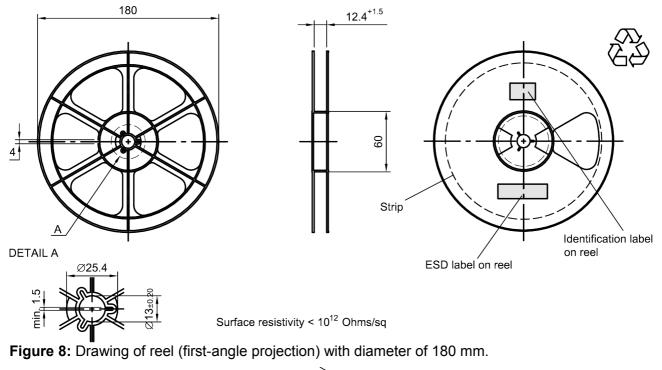
Table 1: Tape dimensions.

E2	10.25 mm (min.)
F	5.5±0.05 mm
G	0.75 mm (min.)
K <sub>0</sub>	1.5±0.1 mm
P <sub>0</sub>	4.0±0.1 mm

<b>P</b> <sub>1</sub>	4.0±0.1 mm
P <sub>2</sub>	2.0±0.1 mm
Т	0.3±0.05 mm
W	12.0+0.3/-0.1 mm



#### 10.2 Reel with diameter of 180 mm



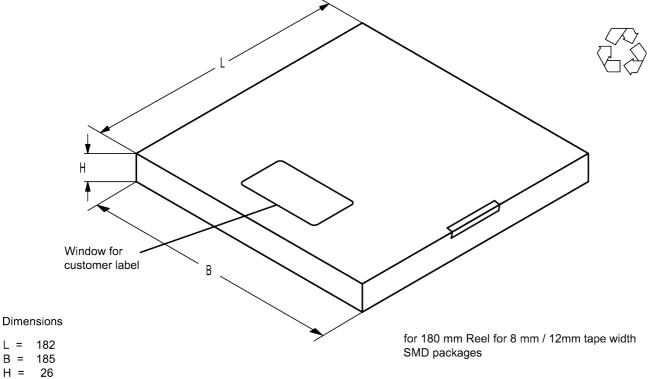
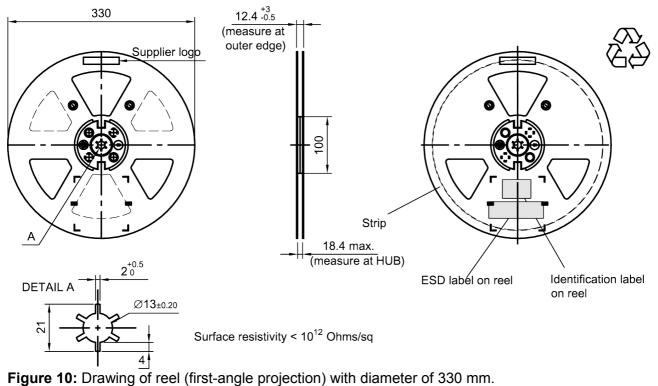
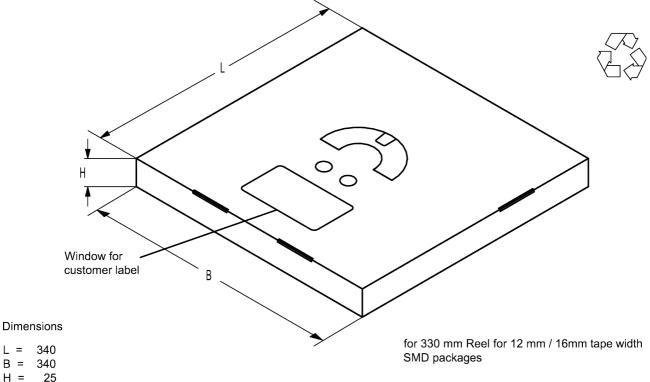
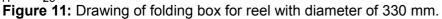


Figure 9: Drawing of folding box for reel with diameter of 180 mm.

#### 10.3 Reel with diameter of 330 mm







#### 11 Marking

Products are marked with device designation, lot number, as well as production location and date code.

Device designation: The 4-character device designation of the ordering code is used for the marking.

Example for 4-character device designation: B3xxxxB1234xxxx

■ Lot number: The last 5 digits of the lot number are used for the marking.

Example: 12345

Production location and date code: The production location is Wuxi (encoded in the first character 'C'). The production date code is encoded in the last three characters according to Table 2.

	1 <sup>st</sup> digit (day)					2 <sup>nd</sup> digit (year)				3 <sup>rd</sup> digit	(month)		
Day	Code	Day	Code	Day	Code	Year	Code	Year	Code	Month	Code	Month	Code
1	1	11	А	21	М	2010	А	2022	Р	Jan	1	Jul	7
2	2	12	В	22	Ν	2011	В	2023	R	Feb	2	Aug	8
3	3	13	С	23	Р	2012	С	2024	S	Mar	3	Sep	9
4	4	14	D	24	R	2013	D	2025	Т	Apr	4	Oct	0
5	5	15	E	25	S	2014	E	2026	U	May	5	Nov	N
6	6	16	F	26	Т	2015	F	2027	V	Jun	6	Dec	D
7	7	17	н	27	U	2016	Н	2028	W				
8	8	18	J	28	V	2017	J	2029	Х				
9	9	19	к	29	W	2018	К	2030	Z				
10	0	20	L	30	Х	2019	L	2031	А				
				31	Z	2020	М	2032	В				
						2021	Ν	and	so on				

 Table 2: Production date code.

Example of how to decode production location and date code:

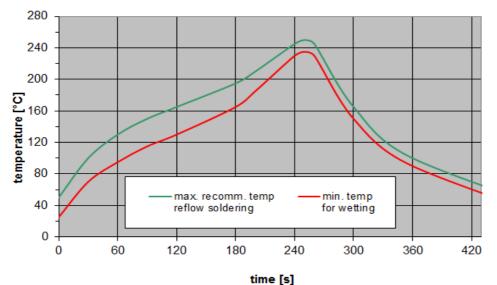
Location:	С		$\rightarrow$	Wuxi
Day:	Т		$\rightarrow$	26 <sup>th</sup>
Year:	F		$\rightarrow$	2015
Month:		6	$\rightarrow$	June

### 12 Soldering profile

The recommended soldering process is in accordance with IEC 60068-2-58 – 3<sup>rd</sup> edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
<i>T</i> > 220 °C	30 s to 70 s
<i>T</i> > 230 °C	min. 10 s
<i>T</i> > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	_
peak temperature T <sub>peak</sub>	250 °C +0/-5 °C
wetting temperature $T_{min}$	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature T	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).



**Figure 12:** Recommended reflow profile for convection and infrared soldering – lead-free solder.

#### 13 Annotations

#### 13.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

#### 13.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

#### 13.3 Shelf life

The shelf life of components is determined by solderability of the package terminals. It is specified as 2 years from manufacturing date assuming the following conditions:

- storage in original packaging and non-aggressive atmosphere,
- storage temperature ranging from −25 °C to +40 °C, and
- storage humidity with ≤ 75 % r.h. mean annual humidity, ≤ 95 % r.h. for max. 30 days / year, and no dew condensation.

#### 14 Cautions and warnings

#### 14.1 Display of ordering codes for RF360 products

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#### 14.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

#### 14.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

#### 14.4 Package information

#### Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

#### Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

#### **Projection method**

Unless otherwise specified first-angle projection is applied.

#### 15 Important notes

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